

Amendments to the Specification

Please replace the title with the following new title:

OPTICAL COMMUNICATIONS ADAPTER MODULE CONFIGURED FOR
USE INSIDE A XENPAK-SIZED MODULE

Please replace paragraph [0021] in its entirety with the following replacement paragraph:

[0021] Figure 1 shows an optical communications network 100 in accordance with one embodiment of the present invention. In one embodiment, the communications network 100 includes a server 102, router 104, and a hub 106 that is in communication with a network 108. It should be appreciated that the server 102, router 104, and the hub 106 are exemplary computing apparatuses (e.g., client devices, client computing devices, etc.) that may be in optical communication with the network 108. In one embodiment, the client device may include a microprocessor and a network processor coupled to one another. It should be appreciated that the network processor and the microprocessor may be coupled in any suitable fashion. Consequently, any suitable types and/or numbers of computing or telecommunications devices may utilize an optical communications adapter module 110 (e.g., XPAK board assembly to XENPAK-sized module, X2 board assembly to XENPAK-sized module, XFP board assembly to XENPAK-sized module, etc.) described herein to communicate with the network 108. The module 110 as described herein may be any apparatus that may be of any suitable configuration that can facilitate data communications utilizing an optical

communications assembly board from one type of optical communications device within a packaging or casing of another optical communications device with a different size and/or configuration. In one embodiment, the module 110 is a XENPAK-sized module or transponder that utilizes an assembly board from a different type of optical communications module such as, for example, an XPAK assembly board, an X2 assembly board, an XFP assembly board, etc.